

#### 3.5x2.8mm SURFACE MOUNT LED LAMP



#### **ATTENTION**

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: AAA3528SURKZGQBDS

Hyper Red Green Blue

#### **Features**

- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

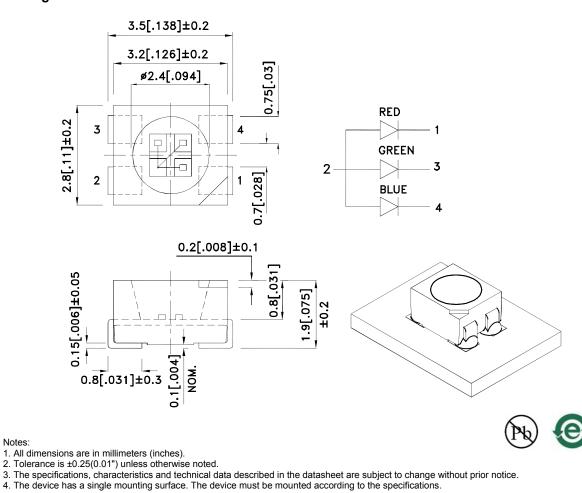
The Blue source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### **Package Dimensions**



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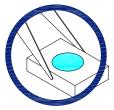
ERP: 1201006667

#### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

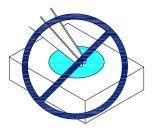
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

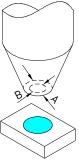




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

All design applications should refer to Kingbright application notes available at <a href="http://www.KingbrightUSA.com/ApplicationNotes">http://www.KingbrightUSA.com/ApplicationNotes</a>

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#### **Selection Guide**

	Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			-	Min.	Тур.	201/2
	AAA3528SURKZGQBDS	Hyper Red (AlGaInP)	Water Clear	200	320	120°
				*55	*100	
		Green (InGaN)		400	600	
				*400	*600	
		Blue (InGaN)		55	130	
				*55	*130	

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Max.	Units	Test Conditions		
λpeak	Peak Wavelength	Hyper Red Green Blue	650 515 468	*645 *515 *460		nm	Ir=20mA		
λD [1]	Dominant Wavelength	Hyper Red Green Blue	630 525 470	*630 *525 *465		nm	IF=20mA		
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	28 30 25			nm	IF=20mA		
С	Capacitance	Hyper Red Green Blue	35 45 100			pF	VF=0V;f=1MHz		
VF [2]	Forward Voltage	Hyper Red Green Blue	1.95 3.3 3.3		3.3		2.5 4.1 4.0	V	IF=20mA
lr	Reverse Current	Hyper Red Green Blue			10 50 50	uA	VR=5V		

### Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Blue	Units		
Power dissipation	75	123	120	mW		
DC Forward Current	30	30	30	mA		
Peak Forward Current [1]	185	150	150	mA		
Reverse Voltage	5 V					
Operating Temperature	-40°C To +85°C					
Storage Temperature	mperature -40°C To +85°C					

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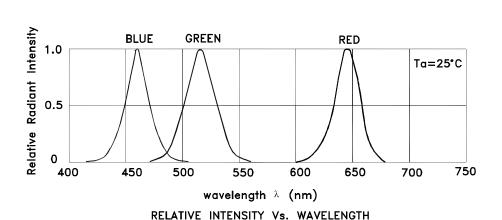
Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

<sup>1.</sup>Wavelength: +/-1nm.

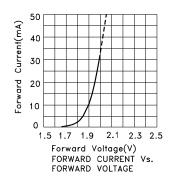
<sup>2.</sup>Forward Voltage: +/-0.1V.

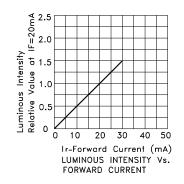
\* Wavelength value is traceable to the CIE127-2007 compliant national standards.

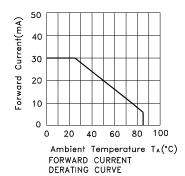
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

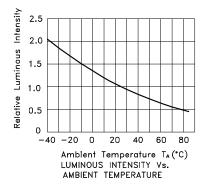


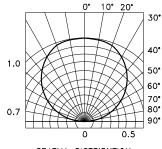
### AAA3528SURKZGQBDS Hyper Red







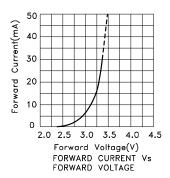


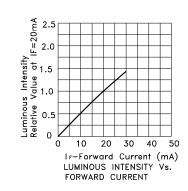


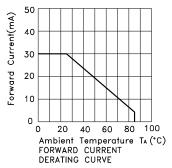
SPATIAL DISTRIBUTION

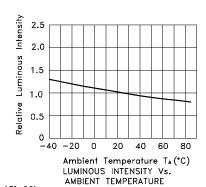
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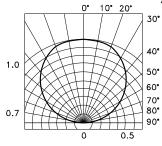
#### Green







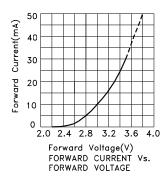


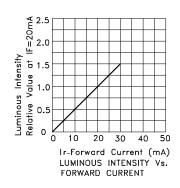


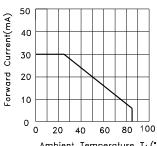
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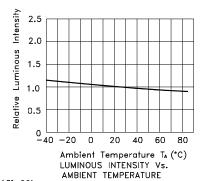
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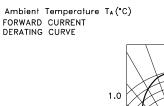
#### Blue



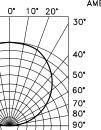








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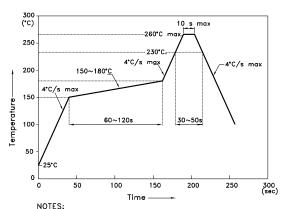
SPATIAL DISTRIBUTION

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#### AAA3528SURKZGQBDS

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



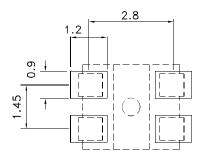
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
  - to high temperature.

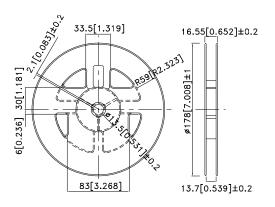
    3.Number of reflow process shall be 2 times or less.

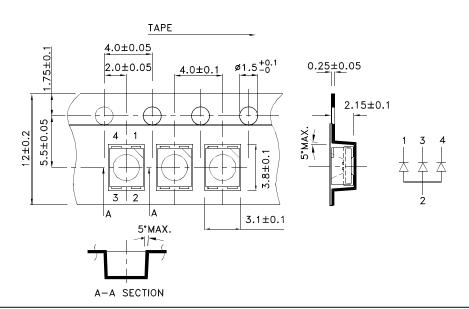
### Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### Tape Dimensions (Units : mm)

#### **Reel Dimension**

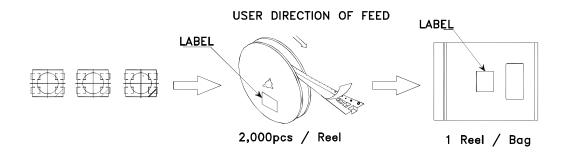


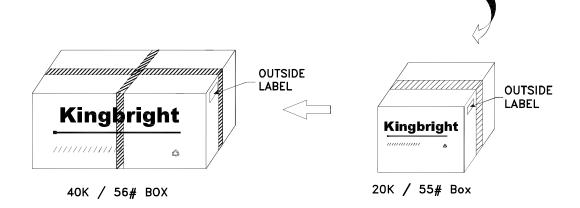


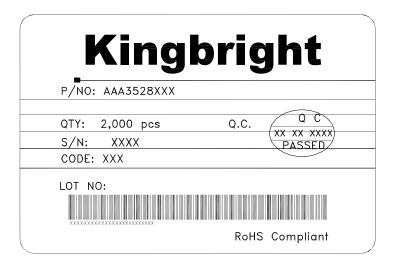
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### PACKING & LABEL SPECIFICATIONS

#### AAA3528SURKZGQBDS







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